

S-MFC5.6

FCOS Package
For contact based application (Controller)

Short Product Overview

May 2010

Chip Card & Security

S-MFC5.6 Short Product Overview		Ref.: Chip_Card_Product_Overview_11/09
Revision History: Current Version 05.10		
Previous Releases:		
Page		

Important: Further information is confidential and on request. Please contact:
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Edition 2010

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Chip Card & Security
81726 Munich, Germany
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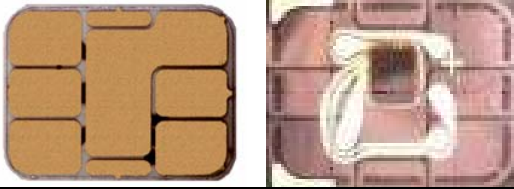
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Product name	S-MFC5.6
Picture	
Product description	Contact based module 6 Contacts FCOS™ technology PET Tape Flip Chip
Typical Applications	Payment, GSM
Pitch	9.5 mm
Dimensions	11 x 8.3 mm
Thickness	max. 538µm
Contact Surface	NiAu
Delivery form	Tape on Reel Reel diameter 330mm
ISO - reference	ISO/IEC 7810 SO/IEC 7816-1 ISO/IEC 10373-1 / -3
Derivatives	S-MFC5.6-6-1, Au surface S-MFC5.6-6-3, Pd surface S-MFC1.6-6-1, Ni coating

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